This method is able to plate non-conductors without using	Method of plating non-conductors and liquid compositions for clear to be plating non-conductors and liquid compositions of plating non-conductors are deposition (2000-129683 C2000-129683 An ABS resin plate (thickness=3mm) was degreased, etched and rinsed, treated with the solution (1 liter) containing 100 ml of 35 % insed, treated with the solution containing 100 ml of 35 % carelytic solution containing 100/liter of carelytic solution containing 100/liter of carelytics and alcohol as reducing agent and catalytic metal is electroless deposition solution containing 100 ml of 35 % carelytics solution containing 100/liter of carelytics solution containing 100/liter of plater of carelytic metal is electroless deposition solution containing 100/liter of plater of carelytics and plated. USE ADVANTAGE This method is able to plate non-conductors without using
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